

S313	2	S295 and S312	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S314	3	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and suppl\$4 and lot).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S315	123	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and suppl\$4 and lot)	US-PGPUB	OR	OFF	2008/08/16 09:31
S316	816	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split) and format and interpret\$5	US-PGPUB	OR	OFF	2008/08/16 09:31
S317	3	S316 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S318	25046	(semiconductor wafer) and (merge split)	US-PGPUB	OR	OFF	2008/08/16 09:31
S319	91	S318 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S320	22	S319 and transact\$4 and (status updat\$3)	US-PGPUB	OR	OFF	2008/08/16 09:31
S321	5021	(transact\$4 and (status updat\$3)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S322	4	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and (merge split) and lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S323	0	((work near3 in near3 (process progress) (wip)) with (semiconductor wafer) with (merge split) with lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S324	8	((work near3 in near3 (process progress) (wip)) with (semiconductor wafer)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31

S325	6	((work near3 in near3 (process progress)) (wip)) with compar\$4).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S326	6	("5889674" "20020188682" "20030236718").pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S327	54333	"700"/\$.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S328	446	S327 and wip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S329	6914	700/95-100,102,108,110,115,116,121,124,214-215.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S330	5483	340/5.8,539.13,539.19,825.69,825.72.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S331	494	379/88.12.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S332	13738	705/1,22,28,39,44.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S333	13821	707/3,200.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S334	12049	709/205,206,219.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S335	2397	714/5,15.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S336	538	718/101.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S337	54415	S329 S330 S331 S332 S333 S334 S335 S336	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S338	541	S337 and (work near3 in near3 (process progress) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S339	3259	transact\$4 near7 (compar\$4 determin\$5 identifi\$4 identification calculat\$4) near7 (status updat\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S340	28	transact\$4 near7 (compar\$4 determin\$5 identifi\$4 identification calculat\$4) near7 (status updat\$3) near7 suppl\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S341	2	transact\$4 with (compar\$4 determin\$5 identifi\$4 identification calculat\$4) with (status updat\$3) with suppl\$4 with (semiconductor wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S342	307	(transaction event state) with (work near3 in near3 (process progress) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S343	474	(transaction event state update status) with (work near3 in near3 (process progress) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S344	168	S337 and S343	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S345	114	S344 and (semiconductor wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S346	63	S345 and suppl\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S347	9	S346 and (transact\$4 near7 (compar\$4 determin\$5 identif\$4 identification calculat\$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S348	4	(transaction event state) with (work near3 in near3 (process progress) (wip)) with lot with (merge split)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S349	5	(transaction event state status) with (work near3 in near3 (process progress) (wip)) with lot with (merge split)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S350	12056	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S351	3343	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S352	2461	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split) and format	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S353	1742	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split) and format and interpret\$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S354	12	S353 and (work near3 in near3 (process progress) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S355	2	S337 and S354	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S356	3	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and suppl\$4 and lot).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S357	123	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and suppl\$4 and lot)	US-PGPUB	OR	OFF	2008/08/16 09:31
S358	816	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split) and format and interpret\$5	US-PGPUB	OR	OFF	2008/08/16 09:31
S359	3	S358 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S360	25046	(semiconductor wafer) and (merge split)	US-PGPUB	OR	OFF	2008/08/16 09:31
S361	91	S360 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S362	22	S361 and transact\$4 and (status updat\$3)	US-PGPUB	OR	OFF	2008/08/16 09:31
S363	5021	(transact\$4 and (status updat\$3)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S364	4	((((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and (merge split) and lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S365	0	((((work near3 in near3 (process progress) (wip)) with (semiconductor wafer) with (merge split) with lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S366	8	((((work near3 in near3 (process progress) (wip)) with (semiconductor wafer)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31

S367	6	((work near3 in near3 (process progress)) (wip)) with compar\$4).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S368	694	transact\$4 near3 deduct\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S369	0	S198 and (((work near3 in near3 (process progress)) (wip)) and (semiconductor wafer))	US-PGPUB	OR	OFF	2008/08/16 09:31
S370	0	S198 and (((work near3 in near3 (process progress)) (wip)) and (semiconductor wafer))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S371	1	S198 and ((work near3 in near3 (process progress)) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S372	104	state near7 ((work near3 in near3 (process progress)) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S373	25	S372 and transact\$4 and event	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S374	2	"20050060212".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S375	1	S374 and state	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S376	39	lot near7 state near7 status	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S377	10	S376 and ((work near3 in near3 (process progress)) (wip))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S378	255	((work near3 in near3 (process progress)) (wip)) near7 (status state)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S379	7	((work near3 in near3 (process progress)) (wip)) near7 (status state) near7 transact\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S380	8	((work near3 in near3 (process progress)) (wip)) with (status state) with transact\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S381	1	S380 not S379	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S382	15	possible with lot with (merge split)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S383	9608	possible near7 (merge split)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S384	31	possible near7 (merge split) near7 event	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S385	1	transaction\$3 near7 update near7 event near7 (merge split) near7 lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S386	3	transaction\$3 same update same event same (merge split) same lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S387	7	transaction\$3 same event same (merge split) same lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S388	2446	((current adj status) (state)) near7 lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S389	1	(current adj status) near7 (state) near7 lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S390	1	(current adj1 status) near7 (state) near7 lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S391	34	(current adj1 status) near7 lot	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

S392	21	S199 and (semiconductor wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S393	7	S392 and transaction\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S394	0	transaction\$3 same event same (merge split) same lot same state	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S395	312658	transaction\$3 s same (merge split) same lot same state	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31
S396	6	transaction\$3 same (merge split) same lot same state	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/08/16 09:31

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INTERFERENCE SEARCH

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S357	123	((work near3 in near3 (process progress) (wip)) and (semiconductor wafer) and suppl\$4 and lot)	US-PGPUB	OR	OFF	2008/08/16 09:31
S358	816	transact\$4 and (status updat\$3) and suppl\$4 and (semiconductor wafer) and (merge split) and format and interpret\$5	US-PGPUB	OR	OFF	2008/08/16 09:31
S359	3	S358 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S360	25046	(semiconductor wafer) and (merge split)	US-PGPUB	OR	OFF	2008/08/16 09:31
S361	91	S360 and (work near3 in near3 (process progress) (wip))	US-PGPUB	OR	OFF	2008/08/16 09:31
S362	22	S361 and transact\$4 and (status updat\$3)	US-PGPUB	OR	OFF	2008/08/16 09:31
S363	5021	(transact\$4 and (status updat\$3)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S364	4	((((work near3 in near3 (process progress)) (wip)) and (semiconductor wafer) and (merge split) and lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S365	0	((((work near3 in near3 (process progress)) (wip)) with (semiconductor wafer) with (merge split) with lot).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
S366	8	((((work near3 in near3 (process progress)) (wip)) with (semiconductor wafer)).clm.	US-PGPUB	OR	OFF	2008/08/16 09:31

S367	6	((work near3 in near3 (process progress)) (wip)) with compar\$4). clm.	US-PGPUB	OR	OFF	2008/08/16 09:31
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